
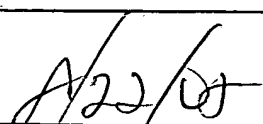


FORM PTO-1449 (Modified)			Attorney Docket No.: 20843-00010US		Application No. Unassigned	
LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)			Applicant: JESUS AL ORTIZ et al.			
			Filing Date: Herewith		Group: Unassigned	
Reference Designation			U.S. PATENT DOCUMENTS			Page 1
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AA	3,469,016	09/1969	Shelton			
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AD	4,106,839	08/1978	Cooper			
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BJ	5,170,009	12/1992	Kadokura			
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CJ	6,123,556	09/2000	Asakura et al.			
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	Document No.	Date	Country	Class	Sub-class	Translation (Yes/No)
OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)						
CL	Adams; <i>Taking the Mystery Out of Metallizing</i> , Vacuum Technology (November 1975) Technical Publishing Company, 4 pages total.					
CM	Adams; <i>Taking the Mystery Out of Metallizing-II</i> , Vacuum Technology (December 1975) Technical Publishing Company, 3 pages total.					
CN	Adams; <i>Taking the Mystery Out of Metallizing-III</i> , Vacuum Technology (February 1976) Technical Publishing Company, 4 pages total.					
CO	Gabower, <i>Thermoformed Vacuum-Metallized Inserts For EMI Shielding</i> , ITEM (1995) The International Journal of EMC, Robar Industries, Inc., pp. 120, 122, 123, and 127.					

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<input checked="" type="checkbox"/> CP	Gabower, <i>Thermoformed Vacuum Metallized Inserts For EMI Shielding of Electronic Devices</i> , Consumer Electronics Show, Flamingo Hilton and Tower, Las Vegas, Nevada, pp. 151-158.		
<input checked="" type="checkbox"/> CO	Gwinner, <i>Vacuum Evaporated Aluminum for Selective Shielding of Plastic Housings</i> , ITEM (1993) The International Journal of EMC, Robar Industries, Inc., pp. 138, 140, 290, 292, 294, and 296.		
<input checked="" type="checkbox"/> CR	Hasler, <i>Electroplating and Vacuum Metalizing</i> , Galvanotechnic (1984) Volume 2, 5 pages total.		
<input checked="" type="checkbox"/> CS	Kimmel et al., <i>Shielding for EMI control...and how to do it right</i> , EDN (January 20, 1994) pp. S59-S69.		
<input checked="" type="checkbox"/> CT	Leonard, <i>What's Hot and What's Not in EMI Shielding of Plastics</i> , Plastics Design Forum (March/April 1993) pp. 32-35.		
<input checked="" type="checkbox"/> CU	Smock, <i>Trend to Lower Cost Resins Will Accelerate</i> , Plastics World (April 1995) 1 page total.		
<input checked="" type="checkbox"/> CV	Rigney, <i>Vacuum Coating</i> , pp. 387-388, 390-410.		
<input checked="" type="checkbox"/> CW	Chomerics, Inc., <i>EMI Shielding for Commercial Electronics</i> (1994) pp. 4-5, 30-33.		
<input checked="" type="checkbox"/> CX	Concise Encyclopedia of Polymer Science & Engineering, John Wiley & Sons, (1990) ISBN 0-471-51253-2, pp. 446-746, 1192-1195.		
<input checked="" type="checkbox"/> CY	Holland, <i>Degassing of Plastic Materials/Plasticizers</i> , Vacuum Deposition of Thin Films, Chapman & Hall Ltd., London (1966) pp. 46-47, 52-53.		
<input checked="" type="checkbox"/> CZ	EMI Protection in Consumer Portable Products, Electronic Packaging and Production (March 1994) pp. 40-44.		
<input checked="" type="checkbox"/> DA	Grgg et al., <i>Machinery's Handbook</i> , Industrial Press, New York (1976) pp. 2299-2301.		
<input checked="" type="checkbox"/> DB	EMI/REI Shielding Guide, General Electric Plastics Co. pp. 1-50.		
<input checked="" type="checkbox"/> DC	Vacuum Metallizing Electrical Problems, TIPS, Midwest Tungsten Service (1986) 2 pages total.		
<input checked="" type="checkbox"/> DD	6100 Thermoformable EMI-Shielding Material, Minnesota Mining & Mfg. Co. (1994) 2 pages total.		
<input checked="" type="checkbox"/> DE	Orion® Designs Economical EMI Shielding Box Without Cutting Corners, Product Brochure, Orion® Industries Incorporated, 1 page total.		
<input checked="" type="checkbox"/> DF	New Solutions for the Electronic Age, Placon Corp., Madison, Wisconsin, Sales Brochure; 1 page total.		
<input checked="" type="checkbox"/> DG	Silver-Coated VALOX FR-1 Film Provides Shielding For Circuit Breakers, GE Films in Action (June 1994) General Electric Co., 1 page total.		
<input checked="" type="checkbox"/> DH	Style CBS Circuit Board Component Shielding - Design Guide 4, Product Brochure, Leader Tech., Tampa, Florida, 2 pages total.		
<input checked="" type="checkbox"/> DI	Ultrasonic Welders Advance Clamshell-Sealing Process, Packaging (October 1994) pp. 78-21.		
<input checked="" type="checkbox"/> DJ	Vacuum Platers, Inc. (VPI), Product Brochure, 4 pages total.		
<input checked="" type="checkbox"/> DK	EMI/RFI Products EE-Evaluation Engineering (April 1995) pp. 64.		
<input checked="" type="checkbox"/> DL	Silver Shielding for the Highest Performance, Swift Textile Metalizing Corporation, ITEM (1995) pp. 11, 15, 109, 112, 113, 115, 116, 212, 213, 267, 269.		
<div style="display: flex; justify-content: space-between;"> <div>EXAMINER </div> <div>DATE CONSIDERED </div> </div>			

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.